



Power MOSFETS

DATASHEET

LM45012NAK8A

N-Channel
Enhancement Mode MOSFET

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Quality Management Systems
ISO 9001:2015 Certificate

N-Channel Enhancement Mode MOSFET

Pin Description

PDFN5*6		Symbol	Symbol	N-Channel	Unit
Top View	Bottom View				
				45	V
				1.2	mΩ
				224	A

Feature

- Fast switching speed
- Reliable and Rugged
- ROHS Compliant & Halogen-Free
- 100% UIS and Rg Tested
- Moisture Sensitivity Level MSL1

Product Summary

Symbol	N-Channel	Unit
V_{DSS}	45	V
$R_{DS(ON)-Max}$	1.2	mΩ
ID	224	A

Applications

- DC-to-DC converters
- Switch Mode Power Supply
- Brushless DC motor control

Ordering Information

Orderable Part Number	Package Type	Form	Shipping	Marking
LM45012NAK8A	PDFN5*6	Tape & Reel	5000 / Tape & Reel	45012

Note : = Lot Code

Absolute Maximum Ratings ($T_J=25^\circ\text{C}$ Unless Otherwise Noted)

Symbol	Parameter	N-Channel	Unit
V_{DSS}	Drain-Source Voltage	45	V
V_{GSS}	Gate-Source Voltage	± 20	
T_J	Maximum Junction Temperature	150	°C
T_{STG}	Storage Temperature Range	-55 to 150	°C
I_S	Diode Continuous Forward Current	$T_c=25^\circ\text{C}$	A
I_{SP}	Diode Pulse Current	$T_c=25^\circ\text{C}$	$400^{\textcircled{1}}$
I_{DM}	Pulse Drain Current Tested	$T_c=25^\circ\text{C}$	$800^{\textcircled{1}}$
I_D	Continuous Drain Current	$T_c=25^\circ\text{C}$	224
		$T_c=100^\circ\text{C}$	141
P_D	Maximum Power Dissipation	$T_c=25^\circ\text{C}$	W
		$T_c=100^\circ\text{C}$	39
I_D	Continuous Drain Current	$T_A=25^\circ\text{C}$	A
		$T_A=70^\circ\text{C}$	26
P_D	Maximum Power Dissipation	$T_A=25^\circ\text{C}$	W
		$T_A=70^\circ\text{C}$	1.3
$I_{AS}^{\textcircled{2}}$	Avalanche Current, Single pulse	$L=0.1\text{mH}$	A
		$L=0.5\text{mH}$	34
$E_{AS}^{\textcircled{2}}$	Avalanche Energy, Single pulse	$L=0.1\text{mH}$	204
		$L=0.5\text{mH}$	290

Thermal Characteristics

Symbol	Parameter	Rating	Unit
$R_{θJC}$	Thermal Resistance-Junction to Case	Steady State	1.3 °C/W
$R_{θJA}^{\textcircled{3}}$	Thermal Resistance-Junction to Ambient	Steady State	60 °C/W

Note $\textcircled{1}$: Max. current is limited by junction temperature.

Note $\textcircled{2}$: UIS tested and pulse width are limited by maximum junction temperature 150°C

Note $\textcircled{3}$: Surface Mounted on 1in² FR-4 board with 1oz

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N-Channel Electrical Characteristics ($T_J=25^\circ\text{C}$ Unless Otherwise Noted)

Symbol	Parameter	Test Conditions	Min.	Typ.	Max.	Unit
Static Electrical Characteristics						
BV_{DSS}	Drain-Source Breakdown Voltage	$V_{\text{GS}}=0\text{V}$, $I_{\text{DS}}=250\mu\text{A}$	45	-	-	V
I_{DSS}	Zero Gate Voltage Drain Current	$V_{\text{DS}}=36\text{V}$, $V_{\text{GS}}=0\text{V}$	-	-	1	μA
$V_{\text{GS(th)}}$	Gate Threshold Voltage	$V_{\text{DS}}=V_{\text{GS}}$, $I_{\text{DS}}=250\mu\text{A}$	1.2	2	2.5	V
I_{GSS}	Gate Leakage Current	$V_{\text{GS}}=\pm 20\text{V}$, $V_{\text{DS}}=0\text{V}$	-	-	± 100	nA
$R_{\text{DS(ON)}}^{\circledast}$	Drain-Source On-state Resistance	$V_{\text{GS}}=10\text{V}$, $I_{\text{DS}}=20\text{A}$	-	0.95	1.2	mΩ
		$V_{\text{GS}}=4.5\text{V}$, $I_{\text{DS}}=10\text{A}$	-	1.6	2.1	
g_{fs}	Forward Transconductance	$V_{\text{DS}}=5\text{V}$, $I_{\text{DS}}=10\text{A}$	-	48	-	S
Dynamic Characteristics ^⑤						
R_{G}	Gate Resistance	$V_{\text{GS}}=0\text{V}$, $V_{\text{DS}}=0\text{V}$, Freq.=1MHz	-	0.95	-	Ω
C_{iss}	Input Capacitance	$V_{\text{GS}}=0\text{V}$, $V_{\text{DS}}=20\text{V}$, Freq.=1MHz	-	5828	-	pF
C_{oss}	Output Capacitance		-	1440	-	
C_{rss}	Reverse Transfer Capacitance		-	80	-	
$t_{\text{d(ON)}}$	Turn-on Delay Time	$V_{\text{GS}}=10\text{V}$, $V_{\text{DS}}=22.5\text{V}$, $I_{\text{D}}=1\text{A}$, $R_{\text{GEN}}=1\Omega$	-	15.3	-	nS
t_{r}	Turn-on Rise Time		-	12.5	-	
$t_{\text{d(OFF)}}$	Turn-off Delay Time		-	49.8	-	
t_{f}	Turn-off Fall Time		-	88	-	
Q_{g}	Total Gate Charge	$V_{\text{GS}}=10\text{V}$, $V_{\text{DS}}=22.5\text{V}$, $I_{\text{D}}=20\text{A}$	-	87.2	-	nC
Q_{gs}	Gate-Source Charge		-	19.5	-	
Q_{gd}	Gate-Drain Charge		-	17.3	-	
Source-Drain Characteristics						
$V_{\text{SD}}^{\circledast}$	Diode Forward Voltage	$I_{\text{SD}}=10\text{A}$, $V_{\text{GS}}=0\text{V}$	-	0.7	1.1	V
t_{rr}	Reverse Recovery Time	$I_{\text{F}}=10\text{A}$, $V_{\text{R}}=22.5\text{V}$ $dI_{\text{F}}/dt=100\text{A}/\mu\text{s}$	-	45.1	-	nS
Q_{rr}	Reverse Recovery Charge		-	39	-	nC

Note ④ : Pulse test (pulse width $\leq 300\mu\text{s}$, duty cycle $\leq 2\%$).

Note ⑤ : Guaranteed by design, not subject to production testing.

N-Channel Typical Characteristics

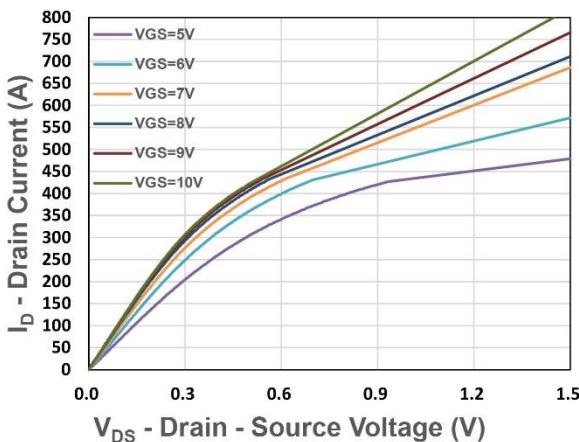


Figure 1. Output Characteristics

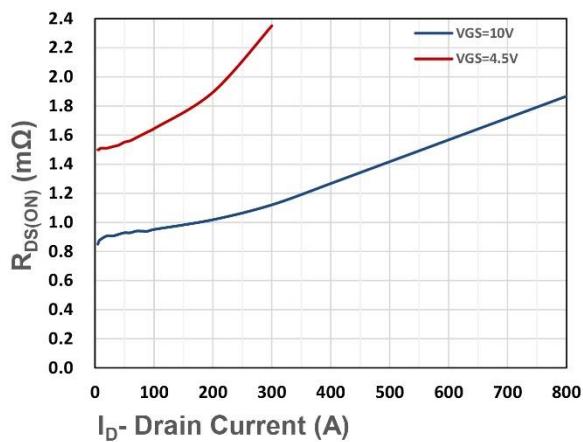


Figure 2. On-Resistance vs. ID

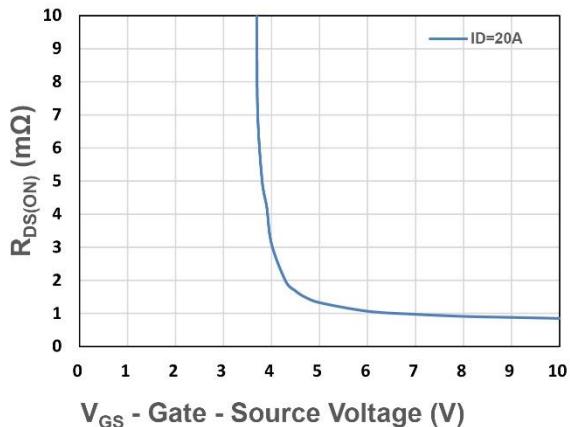


Figure 3. On-Resistance vs. VGS

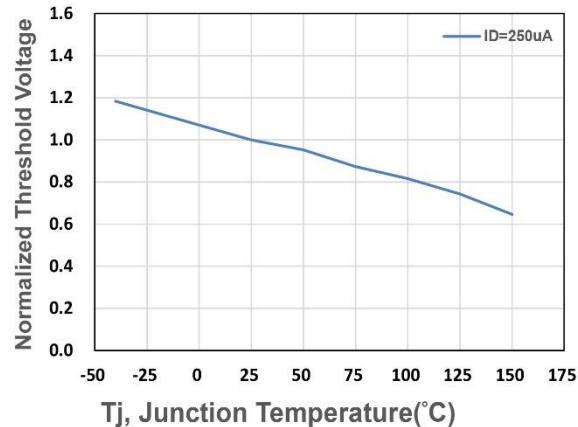


Figure 4. Gate Threshold Voltage

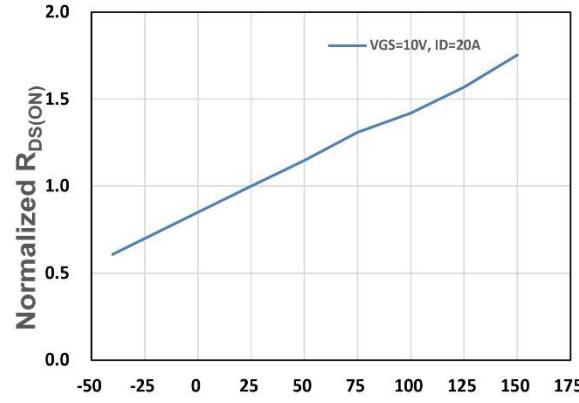


Figure 5. Drain-Source On Resistance

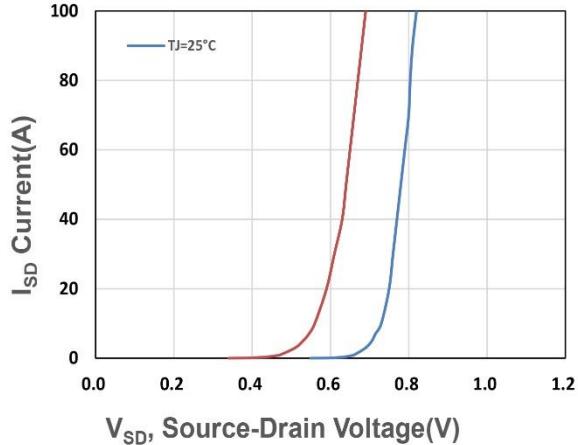
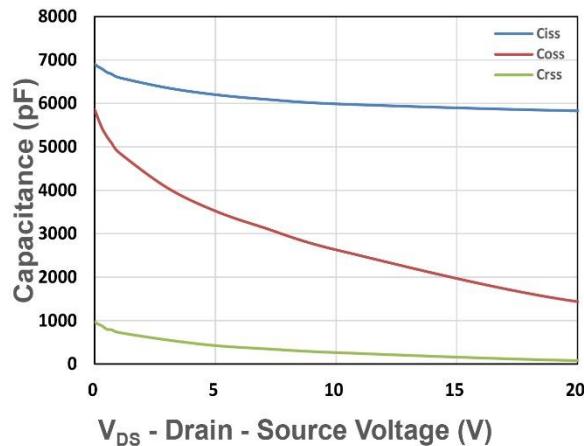


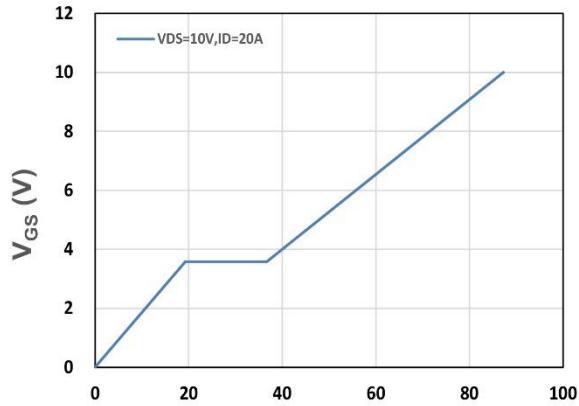
Figure 6. Source-Drain Diode Forward

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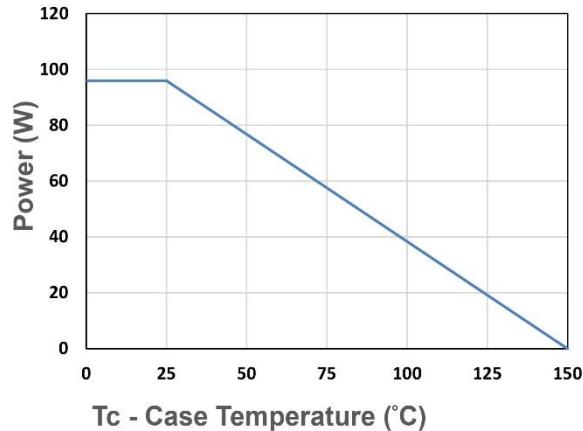
V_{DS} - Drain - Source Voltage (V)

Figure 7. Capacitance



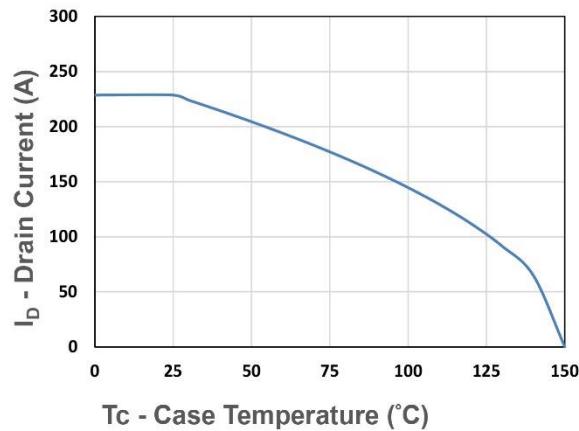
V_{GS} (V)

Figure 8. Gate Charge Characteristics



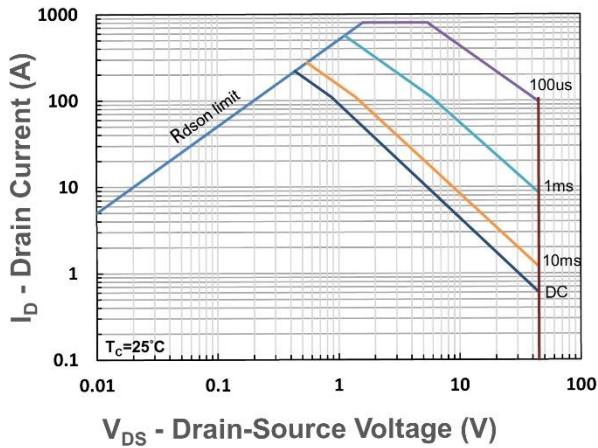
T_c - Case Temperature (°C)

Figure 9. Power Dissipation



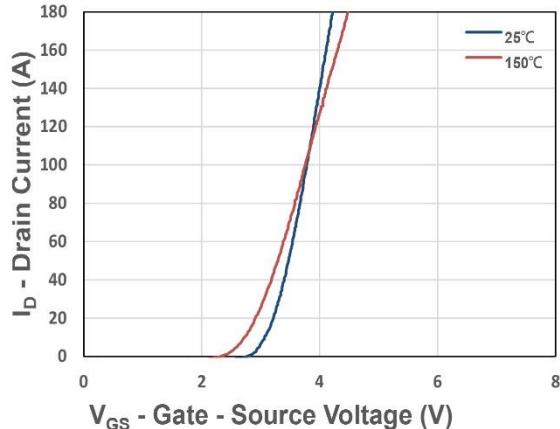
I_D - Drain Current (A)

Figure 10. Drain Current



V_{DS} - Drain-Source Voltage (V)

Figure 11. Safe Operating Area



V_{GS} - Gate - Source Voltage (V)

Figure 12. Transfer Characteristics

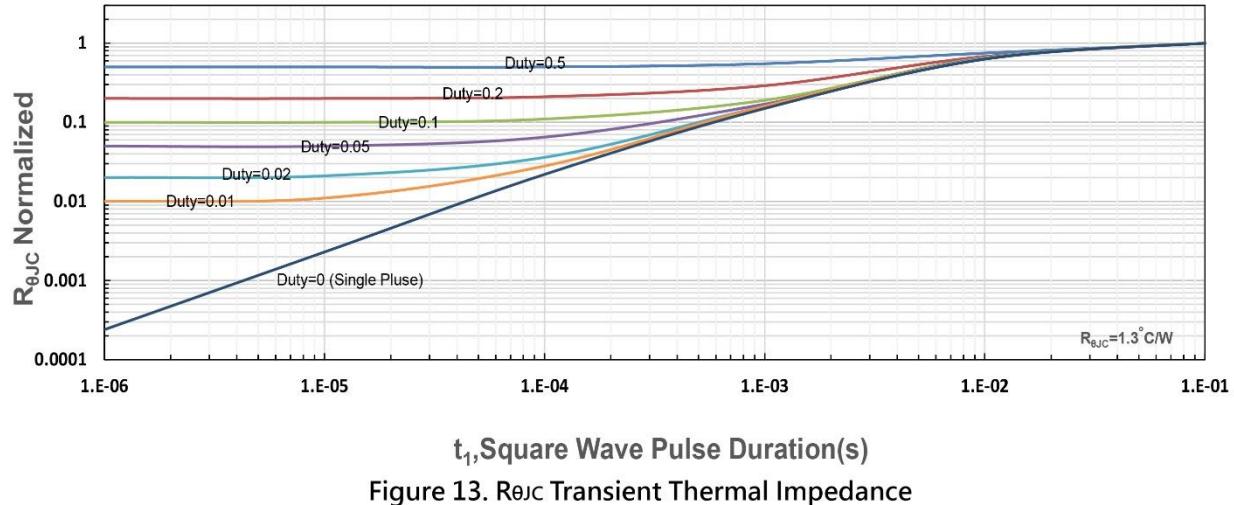


Figure 13. $R_{\theta JC}$ Transient Thermal Impedance